

Instrumentation Amplifiers: characteristics

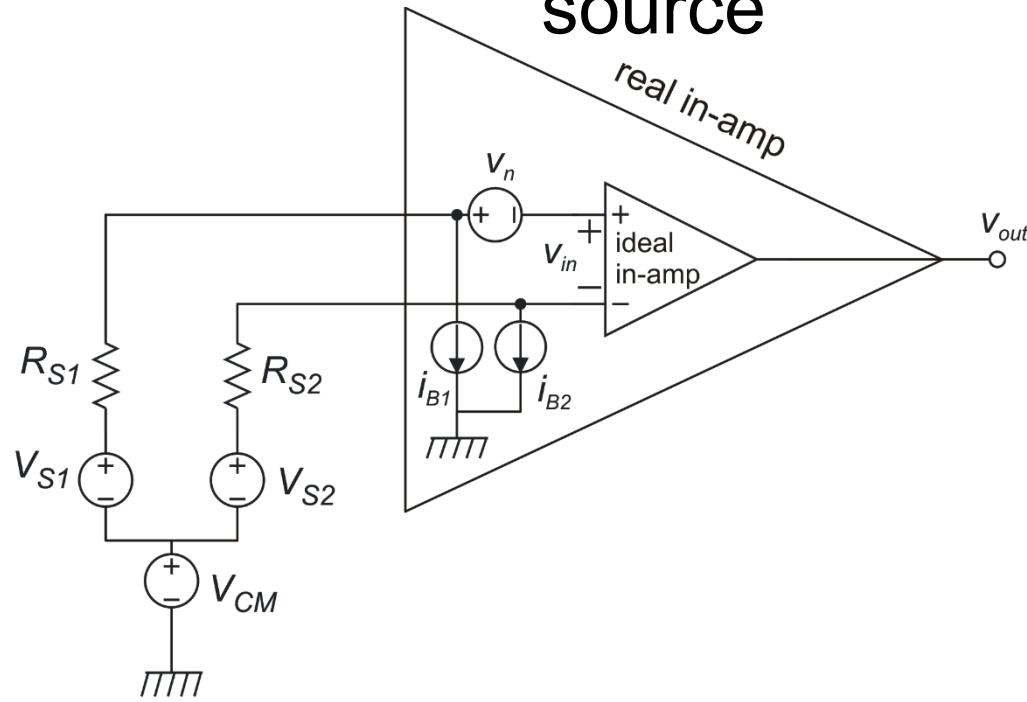
By definition:

- Precise gain
- High input resistance
- Differential input

Other important features

- Low input referred offset voltage
- Low bias currents
- Low input referred voltage and current noise
- High CMRR
- Large bandwidth

Instrumentation Amplifiers: connection to the source



$$v_{in} = V_{S1} - i_{B1}R_{S1} - v_n - (V_{S2} - i_{B2}R_{S2}) = V_{S1} - V_{S2} - v_{nt}$$

$$v_{nt} = v_n + i_{B1}R_{S1} - i_{B2}R_{S2}$$

$$v_{nt} = v_n + R_S(i_{B1} - i_{B2})$$

Balanced case
($R_{S1} = R_{S2} = R_S$)


Offset: $v_n = v_{io}$, $i_{B1} - i_{B2} = I_{B1} - I_{B2} = I_{io}$

$$v_{iot} = v_{io} + R_S (I_{B1} - I_{B2}) = v_{io} + R_S I_{io}$$

Noise: v_n and i_{n1} , i_{n2} are represented by their PSD
(power spectral density)

$$S_{vnt} = S_{vn} + R_S^2 (S_{I1} + S_{I2} - 2S_{I1I2})$$

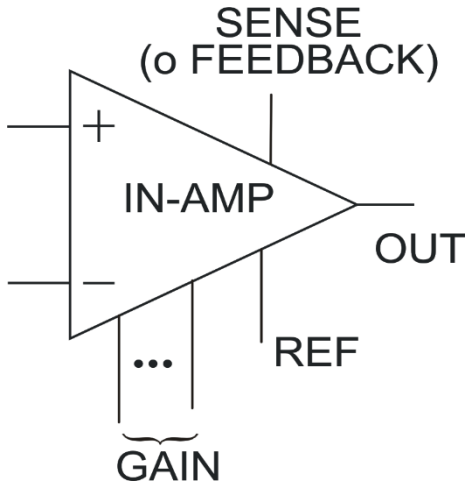
cross-spectrum



If i_{b1} and i_{b2} are uncorrelated and their PSD is S_I :

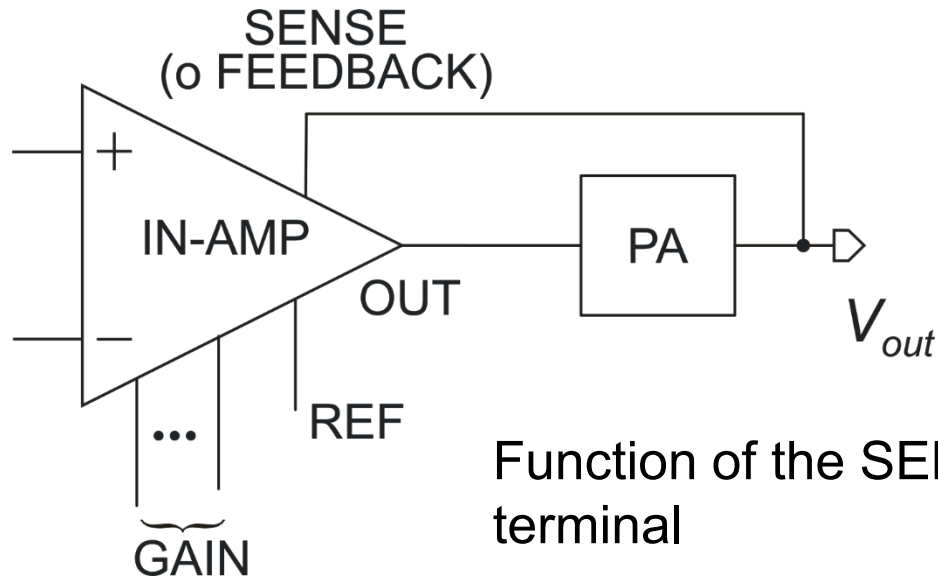
$$S_{vnt} = S_{vn} + 2R_S^2 S_I$$

Monolithic In-Amps



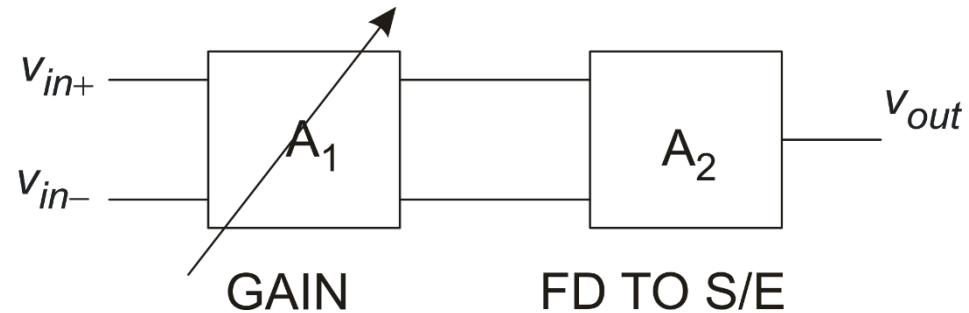
$$V_{out} = G(V_{IN+} - V_{IN-}) + V_{REF}$$

Typical pin configuration



Function of the SENSE terminal

Input and output offset / noise

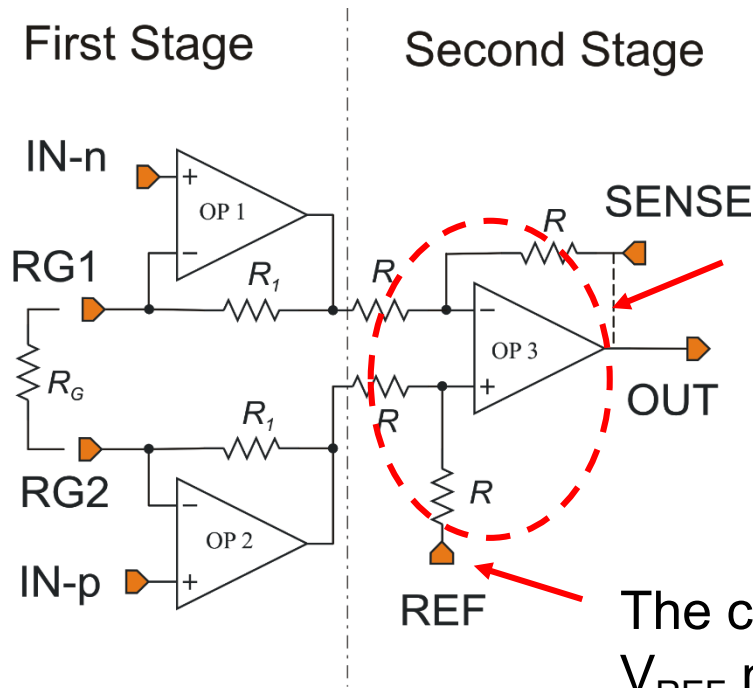


Typical two-stage architecture of In-amps

Generally, $A_2 = 1$, thus:

$$v_{nRTI} = v_{n1} + \frac{v_{n2}}{A_1} = v_{n1} + \frac{v_{n2}}{G}$$

Three-opamp instrumentation amplifier



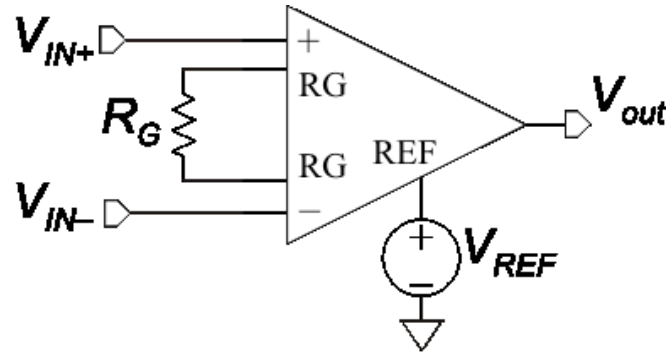
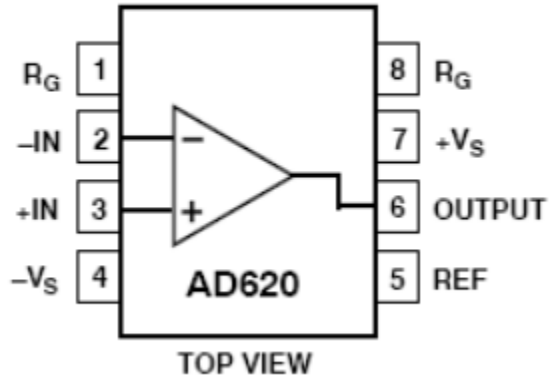
Mismatch of these resistors degrades the CMRR of the second stage. Resistor trimming is necessary for CMRRs > 60 dB

The circuit that provides V_{REF} must have a very low output resistance ($\ll R$)

$$G = 1 + \frac{2R_1}{R_G}$$

Instrumentation Amplifiers

AD 620



$$V_{out} = G(V_{IN+} - V_{IN-}) + V_{REF}$$

$$G = 1 + 49.4k\Omega / R_G$$

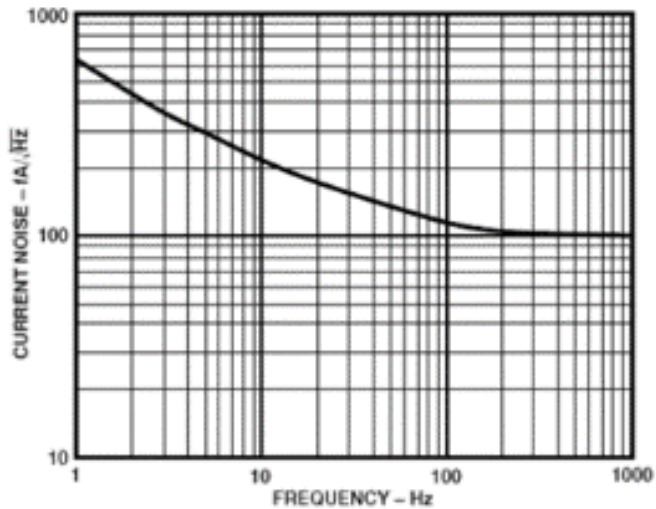


Figure 9. Current Noise Spectral Density vs. Frequency

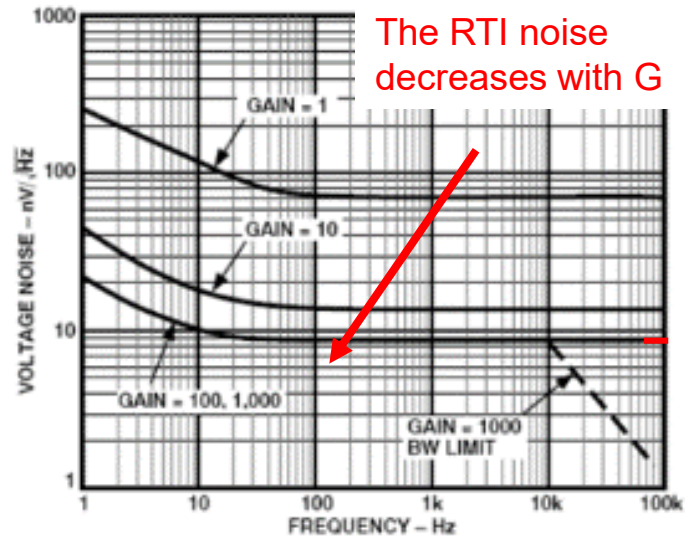


Figure 8. Voltage Noise Spectral Density vs. Frequency, ($G = 1-1000$)

AD 620

GBW does not increase much beyond the G=10 case: BW affected by second stage
 Nearly constant GBW product: BW determined by first stage

AD620											
Model	Conditions	Min	AD620A		Min	AD620B		AD620S ¹		Units	
			Typ	Max		Typ	Max	Min	Typ	Max	
DYNAMIC RESPONSE											
Small Signal -3 dB Bandwidth											
G = 1			1000			1000			1000		kHz
G = 10			800			800			800		kHz
G = 100			120			120			120		kHz
G = 1000			12			12			12		kHz
Slew Rate		0.75	1.2		0.75	1.2		0.75	1.2		V/μs
Settling Time to 0.01%											
10 V Step											
G = 1-100			15			15			15		μs
G = 1000			150			150			150		μs
NOISE											
Voltage Noise, 1 kHz											
$Total\ RTI\ Noise = \sqrt{(e_{ni}^2) + (e_{no}/G)^2}$											
Input, Voltage Noise, e_{ni}			9	13		9	13		9	13	nV/√Hz
Output, Voltage Noise, e_{no}			72	100		72	100				nV/√Hz
RTI, 0.1 Hz to 10 Hz											
G = 1						3.0	6.0				μV p-p
G = 10						0.55	0.8		0.55	0.8	μV p-p
G = 100-1000						0.28	0.4		0.28	0.4	μV p-p
Current Noise											
f = 1 kHz											
0.1 Hz to 10 Hz						100			100		fA/√Hz
						10			10		pA p-p

Slew Rate

Settling times

Output noise >> input noise

Broad-Band Noise: $\sqrt{S_{BB}}$

Low Frequency Noise Integrated over 0.1-10 Hz

Current

Broad-Band Noise: $\sqrt{S_{BB}}$

Low Frequency Noise Integrated over 0.1-10 Hz

AD 620

Such a small offset voltage and offset drift is the result of a laser-trimmed resistor-load BJT input pair

The effective input referred offset (RTI) is a combination of the input and output offset

VOLTAGE OFFSET		(Total RTI Error = $V_{OSI} + V_{OSO}/G$)						
Input Offset, V_{OSI}	$V_S = \pm 5 \text{ V to } \pm 15 \text{ V}$	30	125	15	50	30	125	μV
Over Temperature	$V_S = \pm 5 \text{ V to } \pm 15 \text{ V}$		185		85		225	μV
Average TC	$V_S = \pm 5 \text{ V to } \pm 15 \text{ V}$	0.3	1.0	0.1	0.6	0.3	1.0	$\mu\text{V}/^\circ\text{C}$
Output Offset, V_{OSO}	$V_S = \pm 15 \text{ V}$	400	1000	200	500	400	1000	μV
Over Temperature	$V_S = \pm 5 \text{ V}$		1500		750		1500	μV
Average TC	$V_S = \pm 5 \text{ V to } \pm 15 \text{ V}$	5.0	15	2.5	7.0	5.0	15	$\mu\text{V}/^\circ\text{C}$
Offset Referred to the Input vs. Supply (PSR)	$V_S = \pm 2.3 \text{ V to } \pm 18 \text{ V}$							
G = 1		80	100	80	100	80	100	dB
G = 10		95	120	100	120	95	120	dB
G = 100		110	140	120	140	110	140	dB
G = 1000		110	140	120	140	110	140	dB
INPUT CURRENT								
Input Bias Current		0.5	2.0	0.5	1.0	0.5	2	nA
Over Temperature			2.5		1.5		4	nA
Average TC		3.0		3.0		8.0		$\text{pA}/^\circ\text{C}$
Input Offset Current		0.3	1.0	0.3	0.5	0.3	1.0	nA
Over Temperature			1.5		0.75		2.0	nA
Average TC		1.5		1.5		8.0		$\text{pA}/^\circ\text{C}$

The input bias current and input offset current are similar, since such a small bias current is the result of internal bias current cancellation

POWER SUPPLY		± 2.3	± 18	± 2.3	± 18	± 2.3	± 18	V
Operating Range ⁴								
Quiescent Current	$V_S = \pm 2.3 \text{ V to } \pm 18 \text{ V}$	0.9	1.3	0.9	1.3	0.9	1.3	mA
Over Temperature		1.1	1.6	1.1	1.6	1.1	1.6	mA

The AD 620 in-amp represent a good trade-off between input noise voltage, input bias currents and supply current (quiescent current)

AD 8429

PIN CONNECTION DIAGRAM

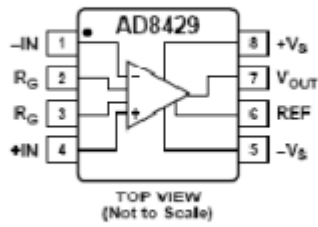


Figure 1.

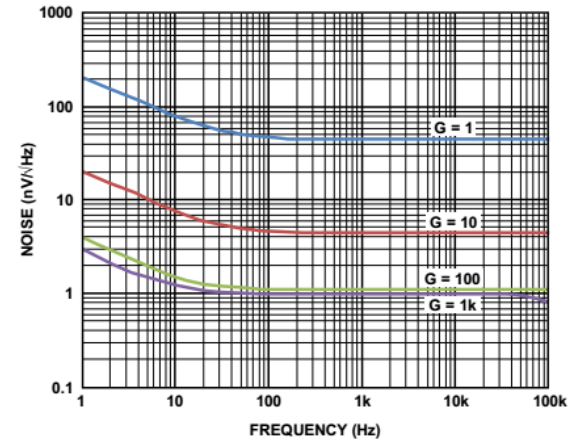


Figure 26. RTI Voltage Noise Spectral Density vs. Frequency

The AD8429 has a much smaller input referred noise than the AD620 (BB-noise)

VOLTAGE NOISE, RTI	$V_{IN+}, V_{IN-} = 0\text{ V}$			
Spectral Density ¹ : 1 kHz				
Input Voltage Noise, e_{ni}		1.0	1.0	nV/√Hz
Output Voltage Noise, e_{no}		45	45	nV/√Hz
Peak to Peak: 0.1 Hz to 10 Hz				
G = 1		2	2	μV p-p
G = 1000		100	100	nV p-p
CURRENT NOISE				
Spectral Density: 1 kHz		1.5	1.5	pA/√Hz
Peak to Peak: 0.1 Hz to 10 Hz		100	100	pA p-p

..... but its input current noise is much larger..

AD 8429

The bias current (dc value) is also much larger than AD620 one

VOLTAGE OFFSET ²						
Input Offset, V_{OSI}			150		50	μV
Average TC		0.1	1	0.1	0.3	$\mu\text{V}/^\circ\text{C}$
Output Offset, V_{OSO}			1000		500	μV
Average TC		3	10	3	10	$\mu\text{V}/^\circ\text{C}$
Offset RTI vs. Supply (PSR)	$V_S = \pm 5\text{ V to } \pm 15\text{ V}$					
G = 1		90		100		dB
G = 10		110		120		dB
G = 100		130		130		dB
G = 1000		130		130		dB
INPUT CURRENT						
Input Bias Current			300		150	nA
Average TC		250		250		$\text{pA}/^\circ\text{C}$
Input Offset Current			100		30	nA
Average TC		15		15		$\text{pA}/^\circ\text{C}$
DYNAMIC RESPONSE						
Small Signal Bandwidth: -3 dB						
G = 1		15		15		MHz
G = 10		4		4		MHz
G = 100		1.2		1.2		MHz
G = 1000		0.15		0.15		MHz

The AD8429 is faster than the AD620

.... but it requires much more quiescent current

POWER SUPPLY						
Operating Range		± 4	± 18	± 4	± 18	V
Quiescent Current		6.7	7	6.7	7	mA
	$T = 125^\circ\text{C}$		9		9	mA

INA 333

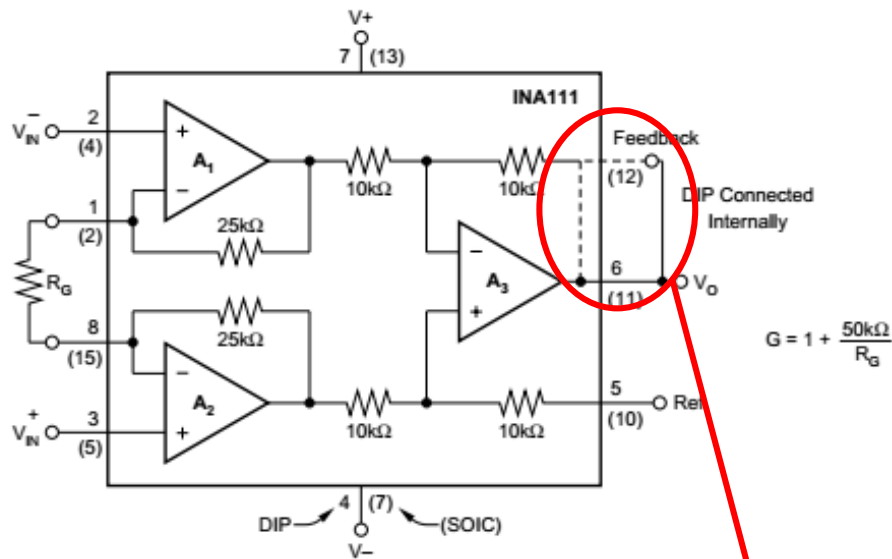
FREQUENCY RESPONSE					
Bandwidth, -3dB					
G = 1			150		kHz
G = 10			35		kHz
G = 100			3.5		kHz
G = 1000			350		Hz
Settling time to 0.01%	t_S				
G = 1		$V_{STEP} = 4V$	50		μs
G = 100		$V_{STEP} = 4V$	400		μs
INPUT BIAS CURRENT					
Input bias current	I_B		± 70	± 200	μA
vs Temperature			See Typical Characteristic curve		$\mu A/^{\circ}C$
Input offset current	I_{OS}		± 50	± 200	μA
vs Temperature			See Typical Characteristic curve		$\mu A/^{\circ}C$
INPUT VOLTAGE NOISE					
Input voltage noise	e_{NI}	$G = 100, R_S = 0\Omega$			
f = 10Hz			50		nV/\sqrt{Hz}
f = 100Hz			50		nV/\sqrt{Hz}
f = 1kHz			50		nV/\sqrt{Hz}
f = 0.1Hz to 10Hz			1		μV_{PP}
Input current noise	i_N				
f = 10Hz			100		fA/\sqrt{Hz}
f = 0.1Hz to 10Hz			2		pA_{PP}

Small bandwidths

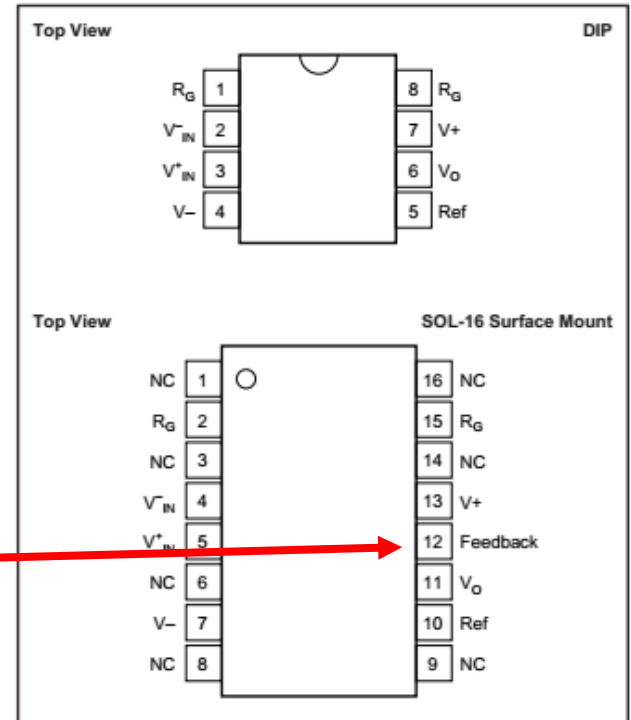
Very low input bias current

Large noise density
AD620 was $9 nV/\sqrt{Hz}$

INA 111: J-Fet input



Note the presence of a sense (Feedback) terminal in the 16 pin case



INPUT								
Offset Voltage, RTI	T _A = +25°C	±100 ± 500/G	±500 ± 2000/G	±200 ± 500/G	±1000 ± 5000/G	μV		
Initial	T _A = T _{MIN} to T _{MAX}	±2 ± 10/G	±5 ± 100/G	±2 ± 20/G	±10 ± 100/G	μV/°C		
vs Temperature	V _R = ±6V to ±18V	2 + 10/G	30 + 100/G	*	*	μV/V		
vs Power Supply								

Offset is considerably worse than AD620 and INA 333, which have a BJT input stage

INA 111

BIAS CURRENT			±2	±20		*	*	pA
OFFSET CURRENT			±0.1	±10		*	*	pA
NOISE VOLTAGE, RTI	G = 1000, R _g = 0Ω							
f = 100Hz			13			*		nV/√Hz
f = 1kHz			10			*		nV/√Hz
f = 10kHz			10			*		nV/√Hz
f _B = 0.1Hz to 10Hz			1			*		μVp-p
Noise Current								
f = 10kHz			0.8			*		fA/√Hz

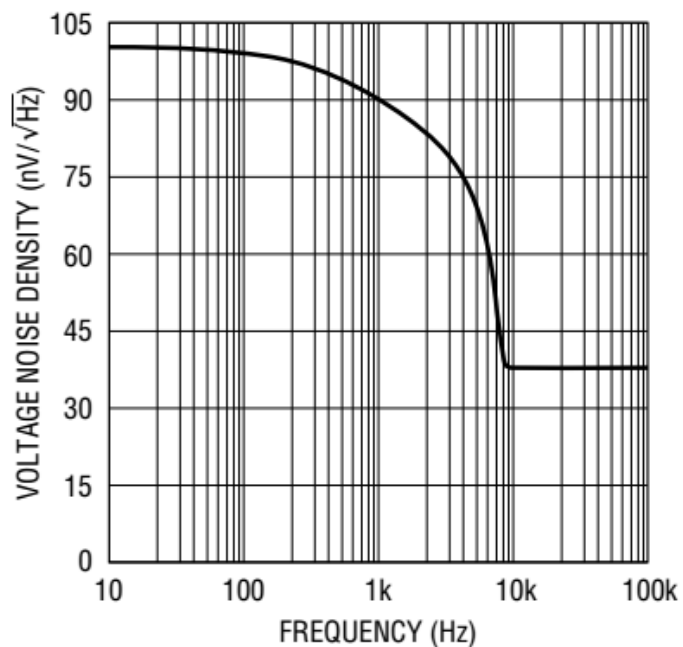
The broad-band input referred noise density is similar to AD 620

.... but the (integrated) low-frequency voltage noise is much worse (was 0.28 μV) in the AD 620

The strong advantage of a JFET input is the negligible noise current density

Precision, Zero-Drift Instrumentation Amplifier

Voltage Noise vs Frequency



The LTC 1100 uses an Autozero technique to cancel the input offset and flicker noise.

The side-effect is foldover, resulting in an increased low-frequency noise density.

Input Offset Voltage	(Note 2)		±1	±10	±1	±10	μV
Input Offset Voltage Drift	(Note 2)	●	±5	±100	±5	±100	nV/°C